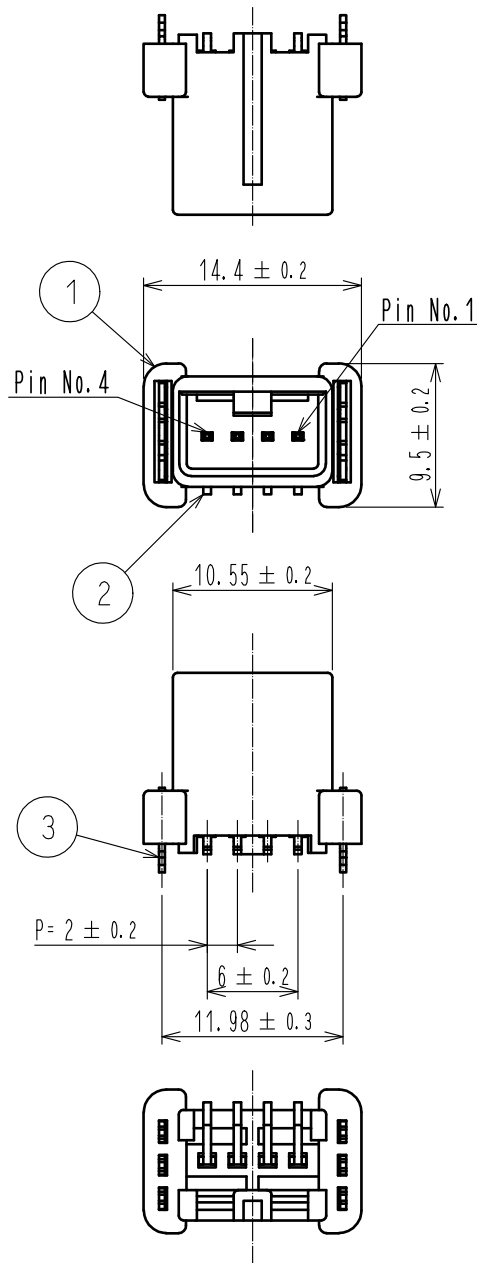


ELV. RoHS COMPLIANT



NOTE1. RECOMMENDED TEMPERATURE PROFILE FOR REFLOW
(REFER RIGHT FIG.).

REFLOW HEATING: FAR-INFLARED, IN THE AIR
OR NITROGEN

REFLOW No.: MAX 2 TIMES

PEAK TEMPERATURE: 250℃

ABOVE 230℃: 20~40s

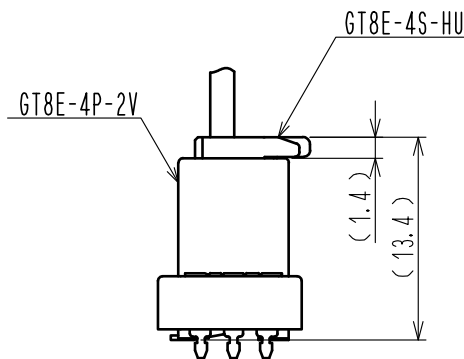
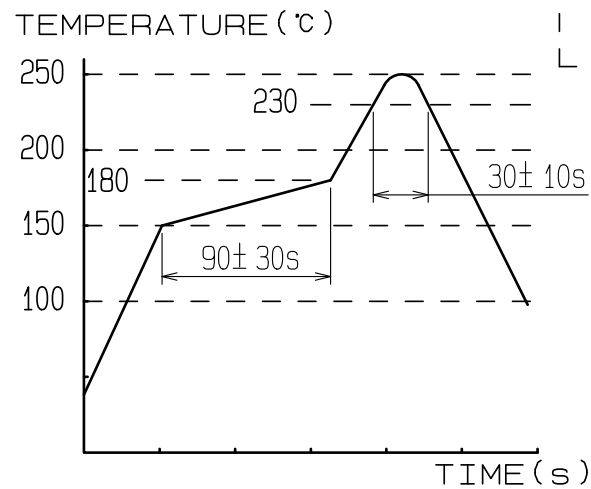
PREHEAT: 150~180℃ (60~120s)

2. SOLDERING TEMPERATURE: 280~300℃ (MAX 2s)

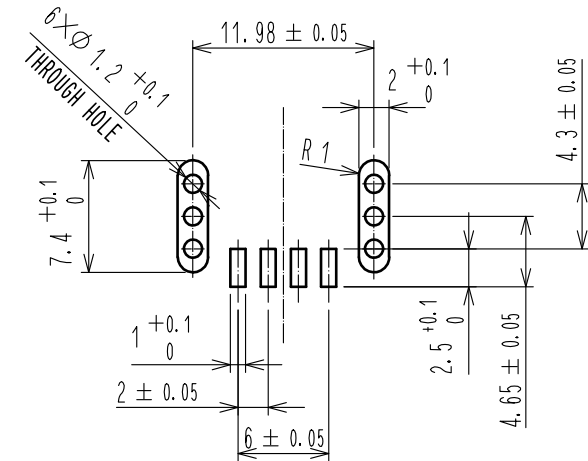
3. COPLANARITY OF LEADS SHALL BE
UNDER 0.1mm.

4. RECOMMENDED THICKNESS FOR
PC BOARD IS 1.6mm.

5. RECOMMENDED THICKNESS FOR
SOLDER PASTE IS 0.15mm.



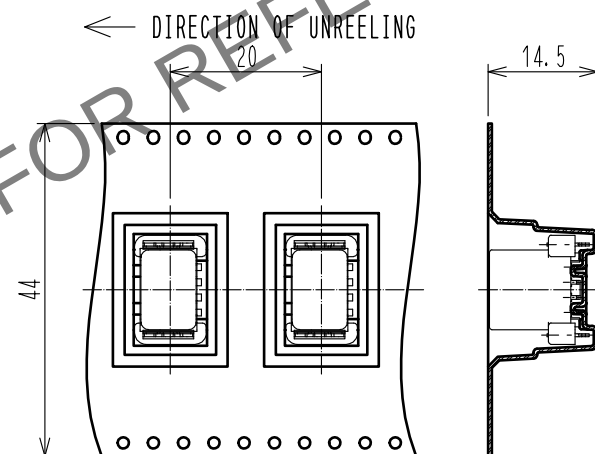
MATED CONNECOTORS



RECOMMENDED PC BOARD PATTERN
(CONNECTOR SIDE)

PACKING STYLE

1. PLACE CONNECTORS INTO ON EMBOSSED CARRIER TAPE.

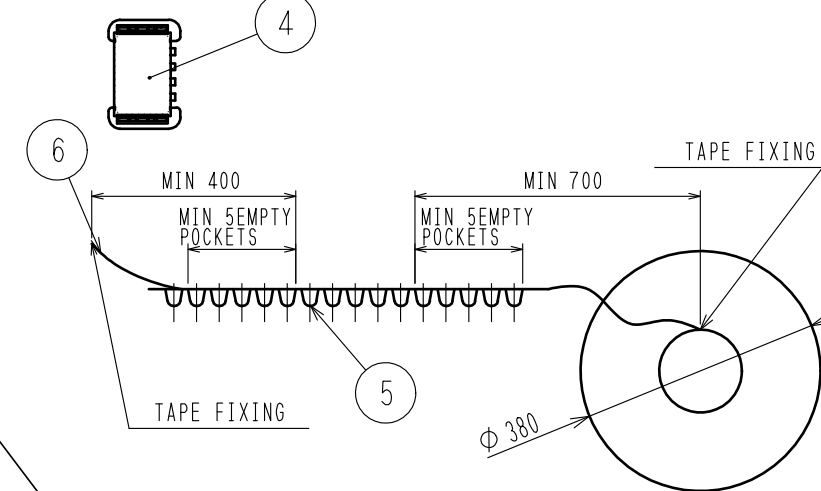


2. PUT A REEL INTO CARDBOARD.

W = (405) (mm)
D = (405) (mm)
H = (51) (mm)

REMOVE THE VACUUM PICK-UP TAPE AFTER MOUNTING THE CONNECTOR

PRODUCT DIRECTION



300 PCS/REEL

3	BRASS	TIN PLATING	6	POLYESTER	(COVER TAPE)
2	BRASS	TIN PLATING	5	PS	(EMBOSSED CARRIER TAPE)
1	PPS	BLACK	4	POLYIMIDE	(VACUUM PICK-UP TAPE)
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS mm		SCALE 2 : 1	COUNT 	DESCRIPTION OF REVISIONS	DESIGNED CHECKED DATE
HRS		HIROSE ELECTRIC CO., LTD.		APPROVED : HK. UMEHARA 20200322	DRAWING NO. EDC-169871-55-00
				CHECKED : HH. TSUKUMO 20200321	PART NO. GT8E-4P-2V(55)
				DESIGNED : DONGCHAN KIM 20200318	CODE NO. CL758-0121-0-55
				DRAWN : YK. MITSUISHI 20200318	